



Part Number : [15912025](#)
Product Description : 2.54mm Pitch SL Wire-to-Board Header, Low Profile, Surface Mount, Single Row, Right-Angle, 3.05mm Pocket, Shrouded, with Press-fit Plastic Peg, 2 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Series Number : 70634
Status : Active
Product Category : PCB Headers and Receptacles
Engineering Number : 70634-0036



Documents & Resources

Drawings

[015912025_sd.pdf](#)
[PK-70873-016-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)
[SOLIDWORKS](#)
[Creo](#)
[Symbol and Footprint \(Multi-Format\)](#)

Specifications

[PS-70400-001.pdf](#)
[PS-70541-001.pdf](#)
[TS-70541-100-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC

	61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	70634
Description	2.54mm Pitch SL Wire-to-Board Header, Low Profile, Surface Mount, Single Row, Right-Angle, 3.05mm Pocket, Shrouded, with Press-fit Plastic Peg, 2 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	SL
UPC	800753771604

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

Physical

Breakaway	No
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
Durability (mating cycles max)	50
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.665/g
Number of Rows	1
Orientation	Right Angle
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No

Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Lead-Free Process Capability	REFLOW
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
SL Single Row Crimp Housings and CPA Retainers	<u>70066</u>
SL Single Row Female Insulation Displacement Connector Assemblies	<u>70400</u>
SL Single Row Female Receptacles	<u>70430</u>